Ultra High-speed High-precision Laser Displacement Sensor

HL-C2 SERIES

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Selection Magnetic Displacement Digital Panel Controller Double-feed Detection

> HL-G1 HL-C2 HL-C1

General terms and conditions..... F-7 Related Information

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■ Sensor selection guide P.1055~

■ About laser beam......P.1499~









HL-C2 series are introduced to limited countries only, because some models falls under WA (Wassenaar Arrangement) 2.B.6.b.1.a, and NSG (Nuclear Suppliers Group) guidelines 1.B.3.b.1. Please contact our office for details.



This product is classified as a Class 1 / Class 2 / Class 3R Laser Product in IEC / JIS standards and a Class 1 (Laser Notice No.50*) /Class II / Class Illa Laser Product in FDA regulations . Never look at or touch the direct laser beam and its reflection.

*This product complies with 21 CFR 1040.10 and 1040.11 Laser Notice No. 50, dated June 24, 2007, issued by CDRH (Center for Devices and Radiological Health) under the FDA (Food and Drug Administration).

Ultra high-speed, high-precision laser displacement sensors using a combination of new technology

Excellent basic performance

These sensors achieve an excellent level of performance in the three basic functions which are required of reflective type laser displacement sensors. They can provide "Surplus", "Reliability" and "Confidence" to production sites which demand high speeds and high precision.

HL-C203F

Sampling

Linearity ±0.03 % Resolution 0.001 mil

HL-C201F Sampling

100 kHz

Resolution

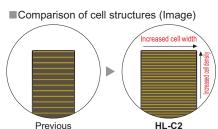
0.0004 mil High-resolution lens

Ultra-high speed calculation processor **MSGB** HL-C203F HDLC-CMOS sensor

HDLC-CMOS sensors

The HDLC-CMOS sensors have been developed specially for the HL-C2 series. High density light-receiving cells and a processing speed which is close to maximum limits result in high resolutions and high speeds which exceed all expectations for laser displacement sensors.

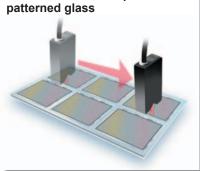
HDLC: High Density Linear Cell





APPLICATIONS

Measurement of the positions of



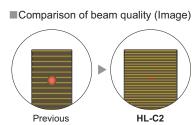
Detection of deformed narrow pitch connector leg pins

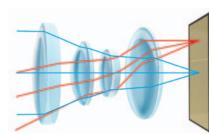


Resolution Linearity

High-resolution lens

High-resolution lens has been newly designed to perfectly suit HDLC-CMOS sensors. The light-receiving part can create images at a minimum point from light received from a variety of different angles to produce images with even greater precision.





Image

MSGB

Exclusive optical equipment and diaphragm structure sustain laser beam of high quality at a radiant density that is close to ideal in the Gaussian distribution. Emission intensity adjustment function, using the newest algorithm, is able to follow any deviation of the light receiving intensity instantaneously maintaining the best emitting condition at all times.

MSGB: Micro Spot Gaussian Beam

Resolution Linearity

Comparison of beam diameter HL-C2

Image

Ultra high-speed calculation processor

All signals are digitalized by a high speed processor while achieving high precision and high speed with its exclusive algorithm.

Sampling



30 µm

Three types of new sensor head released

From the close range to the long range, the best three line-ups are available.

Note: For more details of **HL-C205**□/**C208**□/**C235**□, please refer to our website

HL-C205B(-MK) HL-C205C(-MK) Mesurement center distance: 50mm

HL-C208B(-MK) HL-C208C(-MK) Mesurement center distance: 85mm HL-C235CE-W(MK)

Mesurement center distance: 350mm

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SYSTEM LAYOUT

Controller

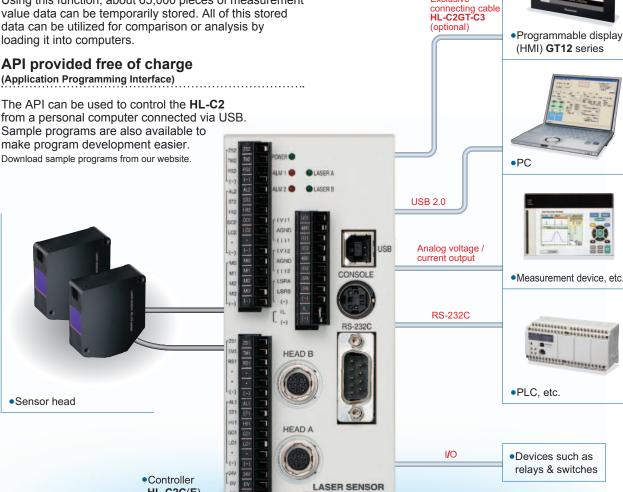
Data buffering function

Using this function, about 65,000 pieces of measurement value data can be temporarily stored. All of this stored data can be utilized for comparison or analysis by loading it into computers.

API provided free of charge

The API can be used to control the HL-C2 from a personal computer connected via USB.





Programmable display (HMI) GT12 series

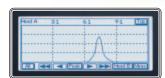
It is possible to use the programmable display GT12 as an exclusive console which enables waveform display and condition setting by installing it in the screen data (free of charge) for HL-C2. (An exclusive cable is necessary.)

Easy to operate using the touch panel and simple display.

HL-C2C(E)

HL-C2C(E)-P

Collimated Beam Digital Panel Controller Metal-sheet Double-feed Detection HL-G1 HL-C2 HL-C1



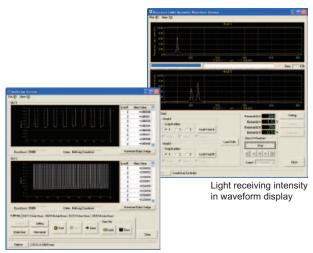
Not only measurement values, but also the wavelength of the amount of light received can be displayed.

Intelligent monitor

HL-C2 series

Waveform monitoring and function setting by computer at great convenience.

Exclusive



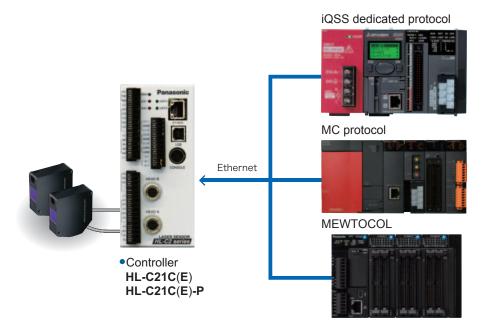
Buffering display

Measurement status can be acquired with a programmable controller easily and without any need for programming!

HL-C21C(-P)

The **HL-C21C** supports the MEWTOCOL (used by our **FP** series) and MC protocols (used by Mitsubishi Electric's MELSEC-Q and MELSEC-L series) as well as the iQSS dedicated protocol (used by Mitsubishi Electric's MELSEC-L series), allowing measured values and other information to be written automatically to the data registers of programmable controllers without any need for programming.

*iQSS is an abbreviation for Mitsubishi Electric's iQ Sensor Solution.



iQSS dedicated protocol

- The iQSS dedicated protocol is supported over Ethernet.
- Connections can be established with MELSEC-L series devices.
- Measured values can be written to data registers.
- Configuration and monitoring are possible with iQSS-compatible GX Works 2.

MEWTOCOL

- MEWTOCOL is supported over Ethernet.
- Connections can be established with FP7 devices.
- · Measured values can be written to data registers.
- Configuration and monitoring are possible using MEWTOCOL's ladder control capability.

MC protocol

- The MC protocol is supported over Ethernet.
- Connections can be established with MELSEC-Q and MELSEC-L series devices.
- Measured values can be written to data registers.
- Configuration and monitoring are possible using the MC protocol's ladder control capability.

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^{*}Logging and traceability functions.

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Controller Metal-sheet

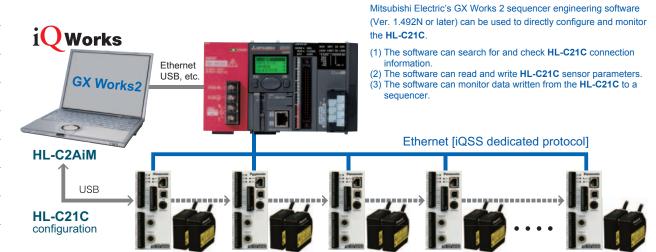
> HL-C2 HL-C1

Double-feed Detection

Connection with a MELSEC-L series Mitsubishi Electric unit with IQSS support

The **HL-C21C** supports Mitsubishi Electric's iQ Sensor Solution (iQSS, the general name used for a sensor solution promoted by Mitsubishi Electric).

Configuration of communications connection settings, monitoring of sensors, and reading and writing of sensor parameters can be accomplished easily without programming, allowing development man-hours during deployment to be reduced. Additionally, the system can be up and running faster.



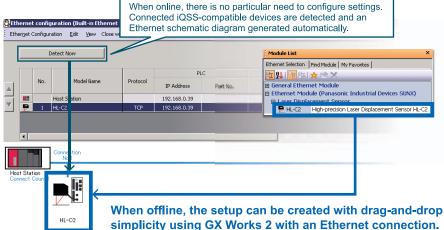
HL-C2AiM: HL-C2 dedicated intelligent monitor (available for download free of charge on our website)

Easy setup

HL-C21C connection settings can be set up using automatic detection of connected devices and drag-and-drop simplicity.

Reduces development man-hours.

Use Mitsubishi Electric's GX Works 2 sequencer engineering software (Ver. 1.492N or later).



simplicity using GX Works 2 with an Ethernet connection.

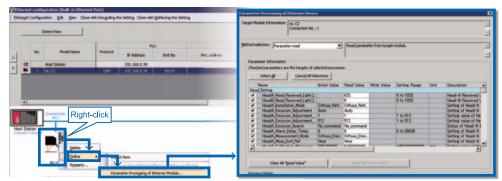
Sensor monitoring

The **HL-C21C**'s measurement status can be easily monitored.



Reading and writing of sensor parameters

HL-C21C sensor parameters can be read and written easily.



- *The **HL-C21C**'s Ethernet communications settings must be configured using **Configurator WD** (Ver. 1.62 or later of our Ethernet communications configuration tool).
- (This software is available for download free of charge from our website.)
- *The MC protocol is supported for the MELSEC-Q series, and sensors can be monitored.

ORDER GUIDE

Sensor heads

Туре	Appearance	Measurement center distance and measuring range	Resolution	Beam size	Model No.	Laser class	
			0.01 µm 0.0004 mil	ø20 μm	HL-C201F		
Small beam spot type	-	At diffuse reflection mode	0.25 μm 0.010 mil	g0 787 mil approx	HL-C201FE	FDA: Class 1	
	LAGER SENECR HL-C2 Seviss	10 ±1 mm 0.394 ±0.039 in	0.01 µm 0.0004 mil	20 × 700 μm	HL-C201F-MK	IEC: Class 1	
Linear beam spot type			0.25 μm 0.010 mil	0.787 × 27.559 mil approx.	HL-C201FE-MK		
			0.025 μm 0.001 mil	#20	HL-C203F		
Small beam spot type	The state of the s	At diffuse	0.25 µm 0.010 mil	ø30 μm ø1.181 mil approx.	HL-C203FE		
		reflection mode 30 ±5 mm 1.181 ±0.197 in	0.025 µm		HL-C203F-MK	FDA: Class II IEC: Class 2	
inear beam spot type		1.101 ±0.137 111	0.001 mil 0.25 μm	30 × 1,200 µm 1.181 × 47.244 mil approx.	HL-C203FE-MK		
			0.010 mil 0.1 µm		HL-C211F		
			0.004 mil 0.25 µm	_	HL-C211FE	FDA: Class II IEC: Class 2	
Small beam spot type			0.010 mil 0.1 µm	ø80 µm ø3.150 mil approx.			
		At diffuse	0.004 mil 0.25 µm	_	HL-C211F5	FDA: Class IIIa IEC: Class 3R	
	Ar	reflection mode	0.010 mil		HL-C211F5E		
		4.331 ±0.591 in	0.004 mil	_	HL-C211F-MK	FDA: Class II IEC: Class 2	
Linear beam spot type			0.010 mil	80 × 1,700 μm 3.150 × 66.929 mil approx.	HL-C211FE-MK	FDA: Class IIIa IEC: Class 3R	
			0.1 µm 0.004 mil		HL-C211F5-MK		
			0.25 µm 0.010 mil		HL-C211F5E-MK		
NEW			0.05 µm 0.002 mil	Ø70 μm Ø2.756 mil approx. 70 × 1,000 μm 2.756 × 39.370 mil approx. Ø70 μm Ø2.756 mil approx.	HL-C205B	FDA: Class II IEC: Class 2 FDA: Class IIIa IEC: Class 3R	
Small beam spot type			0.25 μm 0.010 mil		HL-C205BE		
NEW			0.05 µm 0.002 mil		HL-C205B-MK		
Linear beam spot type	Market Control	At diffuse reflection mode	0.25 μm 0.010 mil		HL-C205BE-MK		
NEW		50 ± 5 mm 1.969 ± 0.197 in	0.05 μm 0.002 mil		HL-C205C		
Small beam spot type			0.25 µm 0.010 mil		HL-C205CE		
			0.05 μm		HL-C205C-MK		
NEW Linear beam spot type			0.002 mil 0.25 μm	70 × 1,000 μm 2.756 × 39.370 mil approx.	HL-C205CE-MK		
			0.010 mil		HL-C208B		
NEW Small beam spot type			0.006 mil 0.25 µm	ø100 µm ø3.937 mil approx.	HL-C208BE		
			0.010 mil 0.15 µm		HL-C208B-MK	FDA: Class II IEC: Class 2	
NEW Linear beam spot type		At diffuse	0.006 mil 0.25 µm	100 × 1,200 μm 3.937 × 47.244 mil approx.			
	A	reflection mode 85 ± 20 mm	0.010 mil 0.15 µm		HL-C208BE-MK		
NEW Small beam spot type		3.346 ± 0.787 in	0.006 mil 0.25 µm	ø100 µm ø3.937 mil approx.	HL-C208C		
on an ocam spot type			0.010 mil	Z z z z z z z z z z z z z z z z z z z z	HL-C208CE	FDA: Class IIIa	
NEW			0.15 µm 0.006 mil	100 × 1,200 µm	HL-C208C-MK	IEC: Class 3R	
Linear beam spot type			0.25 µm 0.010 mil	3.937 × 47.244 mil approx.	HL-C208CE-MK		
NEW Small beam spot type		At diffuse reflection mode	2 μm	ø400 μm ø15.748 mil approx.	HL-C235CE-W	FDA: Class IIIa	
NEW Linear beam spot type		350 ± 200 mm 13.780 ± 7.874 in	0.079 mil	400 × 6,500 μm 15.748 × 255.906 mil approx.	HL-C235CE-WMK	IEC: Class 3R	

Note: For more details of HL-C205□/C208□/C235□, please refer to our website.

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Controllers

Тур	е		Appearance	Model No.	Applicable	e sensor head	
	High-resolution	NPN output		HL-C2C	HL-C201F(-MK) HL-C203F(-MK)	HL-C205B(-MK) HL-C205C(-MK) HL-C208B(-MK) HL-C208C(-MK)	
	High-re	PNP output		HL-C2C-P	HL-C211F(-MK) HL-C211F5(-MK)		
RS232C-compatible	ow-resolution	NPN output		HL-C2CE HL-C201FE(-MK)	HL-C203FE(-MK)	HL-C205BE(-MK) HL-C205CE(-MK)	
	Low-res	PNP output	A. To conten	HL-C2CE-P	HL-C211FE(-MK) HL-C211F5E(-MK)	HL-C208BE(-MK) HL-C208CE(-MK) HL-C235CE-W(MK)	
	olution High-resolution	NPN output		HL-C21C	HL-C201F(-MK) HL-C203F(-MK)	HL-C205B(-MK) HL-C205C(-MK)	
		PNP output		HL-C21C-P	HL-C211F(-MK) HL-C211F5(-MK)	HL-C208B(-MK) HL-C208C(-MK)	
Ethernet-compatible		NPN output		HL-C21CE	HL-C201FE(-MK) HL-C203FE(-MK)	HL-C205BE(-MK) HL-C205CE(-MK)	
	Low-resolution	PNP output	1	HL-C21CE-P	HL-C211FE(-MK) HL-C211F5E(-MK)	HL-C208BE(-MK) HL-C208CE(-MK) HL-C235CE-W(MK)	

Programmable display

It is possible to use the programmable display as an exclusive console which enables waveform display and condition setting by installing it in the screen data (free of charge) for HL-C2.

Designation	Appearance	Model No.	LCD	Power supply	Communication port	Color of front panel	SD memory card slot
		AIG12MQ02D	STN monochrome			Pure black	
GT12M	GT12	AIG12MQ12D	LCD (white / pink / red		RS-232C	T dre black	Available
GTIZW		AIG12MQ03D	backlight)			Hairline silver	
		AIG12MQ13D		24 V DC			Available
		AIG12GQ02D		24 V DC			
GT12G	GT19	AIG12GQ12D	STN monochrome (green / pink / red				Available
G112G	120	AIG12GQ03D	backlight)			Hairline silver	
		AIG12GQ13D				namme silver	Available

Notes: 1) The screen data differs depending on the language. Please download as necessary.

- 2) To install the screen data in the display, prepare a PC and a USB cable (A \Leftrightarrow mini-B connector type) separately.
- 3) The provided console screen data has no function to write the data into / download the data from SD memory card.
- 4) Please refer to our website for more details about programmable display GT12.

Options

Designation	Appearance	Model No.	Description			
ND filter		HL-C2F01	When the amount of reflected light is large at is installed, reducing the amount of laser ligh precision measurement. (Light detection rate	t to an appropriate level enables a higher		
		HL-C2CCJ2	Length: 2 m 6.562 ft, Weight: 0.2 kg approx.			
				HL-C2CCJ5	Length: 5 m 16.404 ft, Weight: 0.4 kg approx.	Cabtyre cable with connector on both ends
Sensor head extension cable		HL-C2CCJ10	Length: 10 m 32.808 ft, Weight: 0.7 kg approx.	Cable outer diameter: ø6.6 mm ø0.260 ir		
		HL-C2CCJ20	Length: 20 m 65.617 ft, Weight: 1.4 kg approx.	Connector outer diameter: ø14.7 mm ø0.579 in max.		
		HL-C2CCJ30	Length: 30 m 98.425 ft, Weight: 2.0 kg approx.			
GT series connector cable for HL-C2		HL-C2GT-C3	Length: 3 mm 9.843 ft	Cable to connect the GT12 and HL-C2 series controller		

SPECIFICATIONS

Sensor heads

		Туре			Small bear	m spot type			
Item	1	Model No.	HL-C201F(E)	HL-C2	03F(E)	HL-C2	11F(E)	HL-C2	11F5(E)
Setu	ıp mode		Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection
Mea	surement c	enter distance	10 mm 0.394 in	30 mm 1.181 in	26.4 mm 1.039 in	110 mm 4.331 in	106.7 mm 4.201 in	110 mm 4.331 in	106.7 mm 4.201 in
Mea	suring rang	ge (Note 3)	±1 mm ±0.039 in	±5 mm ±0.197 in	±4.6 mm ±0.181 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in
		er of samples]	0.04 µm 0.0016 mil [256] 0.01 µm 0.0004 mil [4,096] (HL-C201FE: 0.25 µm 0.010 mil [256])	0.025 µm 0.0	004 mil [256] 01 mil [4,096] µm 0.010 mil [256])	(HL-C211FI	0.1 µm 0.00	116 mil [256] 4 mil [4,096] 5 5E : 0.25 µm 0.0	110 mil [256])
Line	arity (Note	5)	±0.02 % F.S.(HL-C201FE: ±0.025% F.S.)			±0.03	% F.S.		
Tem	perature ch	naracteristics		0.01 % F	S./°C (HL-C201	1FE: 0.013% F.S	8./℃)		
			Red	semiconductor	laser (Peak emi	ssion wavelengt	h: 658 nm 0.026	mil)	
Light	t source		Class 1 (IEC / JIS / FDA, Laser Notice No.50), Max. output: 0.1 mW	(S), Class II (FDA put: 1 mW	Λ)	Class 3R (IEC / JIS Max. outp	S), Class IIIa (FDA) out: 5 mW
Bear	m size (Not	te 6)	ø20 μm ø0.787 mil approx.	ø30 µm ø1.18	31 mil approx.		ø80 µm ø3.1	µm ø3.150 mil approx.	
Rece	eiving elem	ent	Linear image sensor						
itor	Laser emi	ssion	Green LED (lights up during laser emission)						
Indicato	Measuring	g range	(lights up when near the measureme	nt center distance,		w LED the measuring ran	ge, and lights out w	hen outside of the i	measuring range.)
a	Pollution of	degree			3 (Industrial	environment)			
Environmental resistance	Protection	1		IP	67 (IEC) (exclud	ding the connect	or)		
resis	Ambient te	emperature	0 to +45 °C	+32 to +113 °F (No dew condens	sation), Storage:	–20 to +70 °C –	-4 to +158 °F	
ental	Ambient h	numidity		35 t	to 85 % RH, Stor	rage: 35 to 85 %	RH		
onme	Ambient il	luminance		Incandesc	ent light: 3,000 &	x at the light-rec	eiving face		
invir	Vibration r	resistance	10 to 55 Hz (period: 1	min.) frequency	, 1.5 mm 0.059 i	in amplitude in X	(,Y and Z direction	ons for two hours	s each
Shock resistance 196 m/s² acceleration (20 G approx.) in X,Y and Z directions for three times each									
Cabl	le			Cabtyre	cable, 0.5 m 1.6	640 ft long with c	onnector		
Cabl	le extensior	n	E	xtension up to to	otal 30 m 98.425	ft is possible, w	ith optional cabl	е.	
Mate	erial		Enclosur	e: Die-cast alum	inum, Case cov	er: Die-cast alun	ninum, Front cov	er: Glass	
Weig	ght		250 g approx. (including cable) 300 g approx. (including cable)						
Accessory			English warning label: 1 set [The FDA	regulations conform	ing type includes a s	set of both the IEC la	bel (written in Englis	sh) and JIS label (wri	tten in Japanese)].

Notes: 1) **HL-C201F**, **HL-C201F**, **HL-C211F**, **HL-C211F** fall under the Japanese Export Control. These products are introduced to limited countries only. Please refer to "PRECAUTIONS FOR PROPER USE (p.1085)".

2) Where measurement conditions have not been specified precisely, the conditions used were as follows: supply voltage 24 V DC, ambient temperature +20 °C +68 °F, sampling rate 40 µs, average number of samples: 256, object measured at measurement center distance is made of white ceramic [an aluminum vapor deposition surface reflection mirror was used **HL-C201F(E)**] and digital measurement values.

3) Measuring range at sampling periods of 20 µs and 10 µs is as follows.

Model No.		HL-C201F(E)	HL-C203F(E)		HL-C211F(E), HL-C211F5(E)	
Setup mode		Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection
O a marilia a	20 µs	+0.1 to +1.0 mm +0.004 to +0.039 in	0 to +5.0 mm 0 to +0.197 in	0 to +4.6 mm 0 to +0.181 in	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in
Sampling	10 µs	+0.8 to +1.0 mm +0.032 to +0.039 in	+3.8 to +5.0 mm +0.150 to +0.197 in	+3.6 to +4.6 mm +0.142 to +0.181 in	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in

- 4) The P-P value for the deviation in the digital measurement values at the measurement center range has been converted for the measurement center distance.
- 5) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.
- 6) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.

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PARTICULAR USE SENSORS

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HL-C1

SPECIFICATIONS

Sensor heads

	Тур	e	Linear beam spot type						
Item	Model No	HL-C201F(E)-MK	HL-C203	BF(E)-MK	HL-C211	IF(E)-MK	HL-C211	F5(E)-MK	
Setu	p mode	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	
Meas	surement center distance	10 mm 0.394 in	30 mm 1.181 in	26.4 mm 1.039 in	110 mm 4.331 in	106.7 mm 4.201 in	110 mm 4.331 in	106.7 mm 4.201 in	
Meas	suring range (Note 3)	±1 mm ±0.039 in	±5 mm ±0.197 in	±4.6 mm ±0.181 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	
	olution rage number of samples] e 4)	0.04 µm 0.0016 mil [256] 0.01 µm 0.0004 mil [4,096] (HL-C201FE-MK: 0.25 µm 0.010 mil [256])	0.025 µm 0.0	004 mil [256] 01 mil [4,096] 25 µm 0.010 mil [256])	(HL-C211FE-M		<mark>16 mil [256]</mark> <mark>4 mil [4,096]</mark> 5 5E-ΜΚ : 0.25 μm	0.010 mil [256])	
Linea	arity (Note 5)	±0.02 % F.S.(HL-C201FE-MK: ±0.025% F.S.)			±0.03	% F.S.			
Temp	perature characteristics		0.01 % F	S./°C (HL-C20	IFE-MK: 0.013%	F.S./℃)			
		Rec	semiconductor	laser (Peak emi	ssion wavelengt	h: 658 nm 0.026	mil)		
Light	source	Class 1 (IEC / JIS / FDA, Laser Notice No.50), Max. output: 0.1 mW	C		S), Class II (FDA out: 1 mW	N)	Class 3R (IEC / JIS), Class IIIa (FDA) Max. output: 5 mW		
Bean	n size (Note 6)	20 × 700 μm 0.787 × 27.559 mil approx.	30 × 1,200 μm 1.181 × 47.244 mil approx. 80 × 1,700 μm 3.150 × 66.929 mil app			prox.			
Rece	eiving element	Linear image sensor							
itor	Laser emission		Greer	n LED (lights up	during laser emi	ssion)			
Indicator	Measuring range	(lights up when near the measureme	ent center distance,		w LED the measuring ran	ge, and lights out w	hen outside of the	measuring range.)	
لو	Pollution degree			3 (Industrial	environment)				
Environmental resistance	Protection		IP	67 (IEC) (exclud	ling the connector)				
resis	Ambient temperature	0 to +45 °C	0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F						
ental	Ambient humidity		35 t	o 85 % RH, Sto	rage: 35 to 85 %	RH			
on me	Ambient illuminance		Incandesc	ent light: 3,000 {	x at the light-rec	eiving face			
invire	Vibration resistance	10 to 55 Hz (period: 1	10 to 55 Hz (period: 1 min.) frequency, 1.5 mm 0.059 in amplitude in X,Y and Z directions for two hours each						
	Shock resistance 196 m/s² acceleration (20 G approx.) in X,Y and Z directions for three times each								
Cable Cabtyre cable, 0.5 m 1.640 ft long with connector									
Cable extension Extension				otal 30 m 98.425	ft is possible, w	rith optional cable	e.		
Mate	rial	Enclosur	e: Die-cast alum	inum, Case cov	er: Die-cast alun	ninum, Front cov	er: Glass		
Weig	ht	250 g approx. (including cable)			300 g approx. (including cable)		
٨٥٥٥	ssory	English warning label: 1 set [The FDA	regulations conformi	ing type includes a s	set of both the IEC la	bel (written in Englis	sh) and JIS label (wri	tten in Japanese)].	

Notes: 1) HL-C201F-MK, HL-C201F-MK, HL-C211F-MK, HL-C211F5-MK fall under the Japanese Export Control. These products are introduced to limited countries only. Please refer to "PRECAUTIONS FOR PROPER USE (p.1085)".

2) Where measurement conditions have not been specified precisely, the conditions used were as follows: supply voltage 24 V DC, ambient temperature +20 °C +68 °F, sampling rate 40 µs, average number of samples: 256, object measured at measurement center distance is made of white ceramic [an aluminum vapor deposition surface reflection mirror was used HL-C201F(E)-MK] and digital measurement values.

3) Measuring range at sampling periods of 20 µs and 10 µs is as follows.

Model No.		HL-C201F(E)-MK	HL-C203F(E)-MK		HL-C211F(E)-MK, HL-C211F5(E)-MK	
Setup mode		Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection
Committee	20 µs	+0.1 to +1.0 mm +0.004 to +0.039 in	0 to +5.0 mm 0 to +0.197 in	0 to +4.6 mm 0 to +0.181 in	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in
Sampling	10 µs	+0.8 to +1.0 mm +0.032 to +0.039 in	+3.8 to +5.0 mm +0.150 to +0.197 in	+3.6 to +4.6 mm +0.142 to +0.181 in	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in

- 4) The P-P value for the deviation in the digital measurement values at the measurement center range has been converted for the measurement center
- 5) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.
- 6) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.

SPECIFICATIONS

Controllers

/		Туре	RS-232C-compatible	Ethernet-compatible				
/	Model	NPN output type	HL-C2C(E)	HL-C21C(E)				
Iten	n No.	PNP output type	HL-C2C(E)-P	HL-C21C(E)-P				
Con	nectable se	ensor head	Number of connectate	ole units: Max. 2 units.				
Sup	ply voltage		24 V DC ±10 % including ripple 0.5 V (P-P) 500 mA approx. at 2 sensor heads connected 350 mA approx. at 1 sensor head connected					
Curr	ent consum	nption						
Sam	pling cycle		10 μs, 20 μs, 40 μs, 100 μs,	, 200 μs, 400 μs, 1 ms, 2 ms				
Voltage (Note 2)		Note 2)	Voltage output scale: –5 to +5 V/F. Output range during normal status Output at abnormal status: –10.8 \ Resolution: 2 mV, Linearity: ±0.05 Max. 2 mA, output impedance 50.0	: –10.0 to +10.0 V / or +10.8 V				
Analog output	Current (N	Note 3)	Current output scale: 4 to 20 mA/F Output range during normal status Output at abnormal status: 1 mA o Resolution: 3 μA, Linearity ±0.05% Load impedance: 250 Ωmax., Res	: 2 to 24 mA r 25 mA p F.S.				
Aları	m output		<npn output="" type=""> NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between alarm output and Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)</npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between alarm output and +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>				
	Output op	eration	Opened when the amou	unt of light is insufficient				
	Short-circ	uit protection	Incorp	orated				
	gment outpi GO, LO)	ut	<npn output="" type=""> NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between judgment output to Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)</npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between judgment output to +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>				
	Output op	eration	Opened at ou	atput operation				
	Short-circ	uit protection	Incorporated					
Strol	be output		<npn output="" type=""> NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between strobe output to Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)</npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between strobe output to +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>				
	Output op	eration	,	a determination				
	-	uit protection	<u> </u>	porated				
Rem	note interloc	ck input	<npn output="" type=""> Laser emission is delayed when connected to Common (–). Laser emission stop at open Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Laser emission is delayed when connected to IL (+). Laser emission stop at open Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>				
Lase	Laser control input		<npn output="" type=""> Laser emission is stopped when connected to Common (–). Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Laser emission is stopped when connected to external power (+). Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>				
Zero set input			<npn output="" type=""> Zero set is ON when connected with Common (–). Zero set turns to OFF after continuously connected to Common (–) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Zero set is ON when connected with external power (+). Zero set turns to OFF after continuously connected to external power (+) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>				
Timing input			<npn output="" type=""> ON at/during connection to Common (–) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> ON at/during connection to external power (+) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>				
Rese	et input		<npn output="" type=""> Reset is done when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Reset is done when connected to external power (+). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>				
Memory change input			<npn output="" type=""> Memory is specified when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Memory is specified when connected to external power (+). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>				

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MACHINE VISION SYSTEMS

UV CURING SYSTEMS

SPECIFICATIONS

Controllers

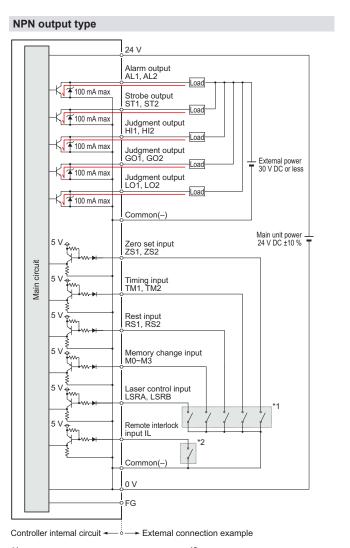
		Туре	RS-232C-compatible	Ethernet-compatible			
	\ Model	NPN output type	HL-C2C(E)	HL-C21C(E)			
Iten	NIa	PNP output type	HL-C2C(E)-P	HL-C21C(E)-P			
	Power		Green LED (light	is up at power on)			
o	Sensor he Laser radi		Green LED (lights up during or immediate	ly before laser emission of sensor head A)			
Indicator	Sensor he		Green LED (lights up during or immediately before laser emission of sensor head B)				
	Alarm 1		Red LED (lights up when OUT1 can not be	measured due to insufficient amount of light)			
	Alarm 2		Red LED (lights up when OUT2 can not be measured due to insufficient amount of light)				
RS-2	232C interfa	ace	Baud rate: 9,600, 19,200, 38,400, 115,200 bit/s				
Ethe	ernet interfa	ce (Note 4)	IEEE802.3u, 10 Base-T / 100 Base-TX RJ45 iQSS dedicated protocol, MC protocol, MEWTo				
USE	3 interface		USB 2.0 Full-speed (USB 1.1 compatible) compliant				
Setti	ing / data d	splay	Programmable display (HMI) GT12 series				
tance	Ambient to	emperature	0 to +50 °C $+32$ to +122 °F (No dew condensation of	r icing allowed), Storage: –20 to +70 °C –4 to +158 °F			
Environmental resistance	Ambient h	umidity	35 to 8	55 %RH			
onment	Vibration i	esistance	10 to 55 Hz frequency (period: 1 min.), 0.75 mm 0.030	in amplitude in X, Y and Z directions for 30 min. each			
Shock resistance		istance	196 m/s² acceleration (20G approx.) in X, Y, and Z directions for three times each				
Material			Enclosure: Polycarbonate				
Weight			450 g s	арргох.			
Accessories			CD-ROM: 1 pc., USB cable (2 m 6.562 ft long): 1 pc., Short bracket: 1 pc.	CD-ROM: 1 pc., USB cable (2 m 6.562 ft long): 1 pc. Short bracket: 1 pc. Ferrite cores (E04SR200935A, by Seiwa Electric Mfg. Co., Ltd.): 3 pcs.			

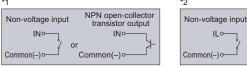
Notes: 1) These products fall under the Japanese Export Control settled by Foreign Exchange and Foreign Trade Act. The products that do not fall under the control are also available. Please contact us for more details.

- 2) The linearity is F.S.=20 V to digital measurement value. Response delay time is the period after update of measurement value.
- 3) The linearity is F.S.=16 mA to digital measurement value. Response delay time is the period after update of measurement value.
 4) The **HL-C21C**'s Ethernet communications settings must be configured using **Configurator WD** (Ver.1.62 or later of our Ethernet communications configuration tool). Please download this software from our website.

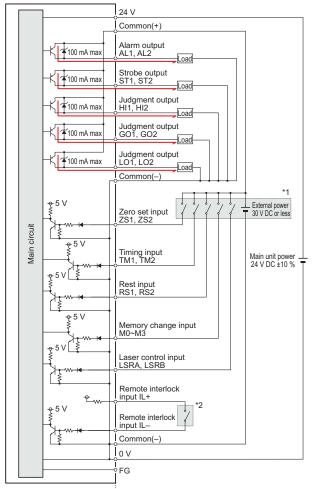
HL-G1 HL-C2

I/O CIRCUIT AND WIRING DIAGRAMS (CONTROLLERS)

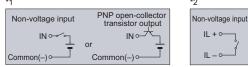




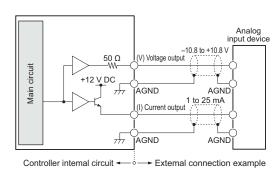
PNP output type



Controller internal circuit ← - ċ --- External connection example



Analog output (Common in NPN output type and PNP output type)



Notes: 1) Do not short-circuit analog output terminals or apply voltage to them. 2) Use shielded wires for analog outputs.

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AREA SENSORS

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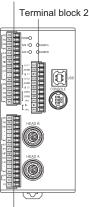
FA COMPONENTS

MACHINE VISION SYSTEMS

UV CURING SYSTEMS

Terminal arrangement

Terminal block 1



Terminal block 3

Terminal block 1

Term	inal	Function
NPN	PNP	1 diletion
(V)	1	Analog voltage output (for OUT1)
AGN	ND	Analog ground
(1)	1	Analog current output (for OUT1)
(V)	2	Analog voltage output (for OUT2)
AGN	ND	Analog ground
(1):	2	Analog current output (for OUT2)
LSF	RA	Laser control input (for Head A) Laser stop during short circuit
LSF	RB	Laser control input (for Head B) Laser stop during short circuit
(-)	Common (–)
IL	IL-	Remote interlock Laser stop when opened.
(-)	IL+	Remote interlock common

Terminal block 2

Terminal	Function			
NPN PNP	i diletion			
ZS2	Zero set input (for OUT2) ON during short circuit (Note 1)			
TM2	Timing input (for OUT2) ON during short circuit			
RS2	Reset input (for OUT2) ON during short circuit			
(-)	Common (–)			
AL2	Alarm output (for OUT2)			
ST2	Strobe output (for OUT2)			
HI2	Judgment HI output (for OUT2)			
GO2	Judgment GO output (for OUT2)			
LO2	Judgment LO output (for OUT2)			
•	Reserved terminal (Note 2)			
(-) (+)	Common (–) / Common (+)			
MO				
M1	Mamany shanga (16 ways)			
M2	Memory change (16 ways)			
M3				
(-)	Common (–)			

Notes: 1) Turn off the terminal in case short circuit lasts for more than one second.

2) Do not connect anything to the reserved terminals; they are connected to the internal circuit.

Terminal block 3

Terminal block o					
Terminal					
NPN	PNP	Function			
ZS1		Zero set input (for OUT1) ON during short circuit (Note 1)			
TM1		Timing input (for OUT1) ON during short circuit			
RS1		Reset input (for OUT1) ON during short circuit			
•		Reserved terminal			
•		Reserved terminal			
(-)		Common (–)			
AL1		Alarm output (for OUT1)			
ST1		Strobe output (for OUT1)			
HI1		Judgment HI output (for OUT1)			
GO1		Judgment GO output (for OUT1)			
LO1		Judgment LO output (for OUT1)			
•		Reserved terminal (Note 2)			
(-)	(+)	Common (–) / Common (+)			
24	1V	24 V DC input for power supply			
0V		Power supply ground 0 V			
FG		Frame ground			
Notes: 1) Turn off the terminal in case					

Notes: 1) Turn off the terminal in case short circuit lasts for more than one second.

2) Do not connect anything to the reserved terminals; they are connected to the internal circuit.

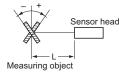
SENSING CHARACTERISTICS (TYPICAL)

HL-C201F(E)

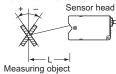
Correlation between measuring distance and error characteristics

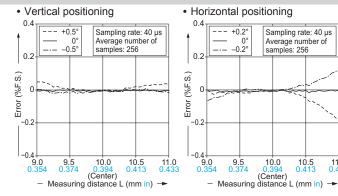
Setup mode: Specular reflection

Aluminum vapor deposition surface reflection mirror (0°, ±0.5°) Vertical orientation



Aluminum vapor deposition surface reflection mirror (0°, ±0.2°) Horizontal orientation





HL-G1 HL-C2

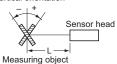
SENSING CHARACTERISTICS (TYPICAL)

HL-C203F(E)

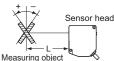
Correlation between measuring distance and error characteristics

Setup mode: Diffuse reflection

White ceramic (0°, ±10°) Vertical orientation



White ceramic (0°, ±10°) Horizontal orientation

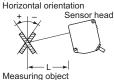


Setup mode: Specular reflection

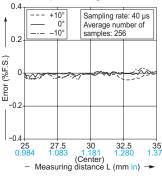
Aluminum vapor deposition surface reflection mirror (0°, ±0.5°) Vertical orientation

Sensor head

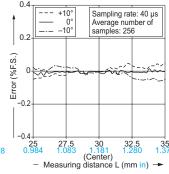
Aluminum vapor deposition surface reflection mirror (0°, ±0.2°)



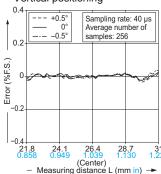
· Vertical positioning

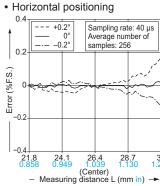


· Horizontal positioning



· Vertical positioning





Measuring object

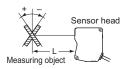
HL-C211F(E) HL-C211F5(E) Correlation between measuring distance and error characteristics

Setup mode: Diffuse reflection

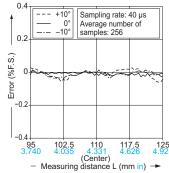
White ceramic (0°, ±10°) Vertical orientation

> Sensor head Measuring object

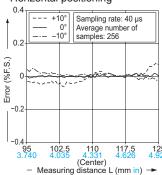
White ceramic (0°, ±10°) Horizontal orientation



· Vertical positioning

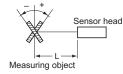


· Horizontal positioning

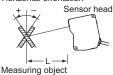


Setup mode: Specular reflection

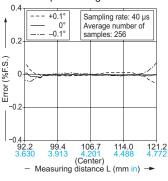
Aluminum vapor deposition surface reflection mirror (0°, ±0.1°) Vertical orientation

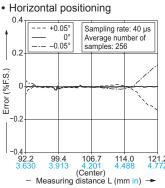


Aluminum vapor deposition surface reflection mirror (0°, ±0.05°) Horizontal orientation



· Vertical positioning





Refer to p.1501 for general precautions and p.1499~ for information about laser beam.

PRECAUTIONS FOR PROPER USE

 This catalog is a guide to select a suitable product. Be sure to read instruction manual attached to the product prior to its use.



- Never use this product as a sensing device for personnel protection.
- · In case of using sensing devices for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.

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HL-G1

HL-C2

HL-C1

PRECAUTIONS FOR PROPER USE

Refer to p.1501 for general precautions and p.1499~ for information about laser beam.

 Do not operate products using methods other than those described in the instruction manual included with each product. Control or adjustment through procedures other than those specified may cause hazardous laser radiation exposure.

 The following labels are attached to the products. Handle each product according to the instruction given on the warning label.

HL-C201F



 This product is classified as a Class 1 Laser Product in IEC / JIS standards and FDA* regulations 21 CFR 1040.10. Do not look at the laser beam through optical devices such as a lens.

HL-C203F , HL-C211F

L-FIN AMERICAN GOT SAN G

 This product is classified as a Class 2 Laser Product in IEC / JIS standards and a Class II Laser Product in FDA regulations 21 CFR 1040.10. Do not look at the laser beam directly or through optical devices such as a lens.

HL-C211F5

 This product is classified as a Class 3R Laser Product in IEC / JIS standards and a Class IIIa Laser Product in FDA regulations 21 CFR 1040.10. Never directly look at or touch the laser beam or its reflection.

*This product complies with 21 CFR 1040.10 and 1040.11 Laser Notice No. 50, dated June 24, 2007, issued by CDRH (Center for Devices and Radiological Health) under the FDA (Food and Drug Administration).

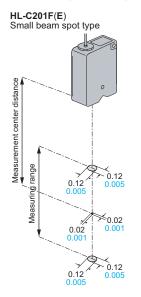
 Below mentioned products fall under Japanese Export Control, which is defined by "Foreign Exchange and Foreign Trade Act".

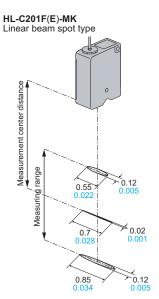
Therefore, anyone who wishes to export or transfer these products outside of Japan is required to obtain the necessary license from the Ministry of Economy, Trade and Industry of Japan.

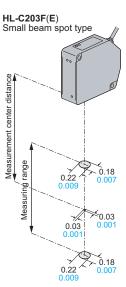
Also, these products fall under international export control regulations, such as Nuclear Suppliers Group (NSG) guidelines 1.B.3.b.1 and Wassenaar Arrangement (WA) 2.B.6.b.1.a, and are objects of the regulation. Please comply with the export control in each country.

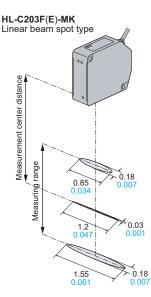
Note: These products are introduced to limited countries only. Please contact our office for details.

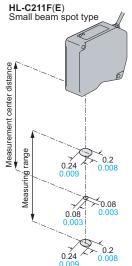
Beam size (Unit: mm in)

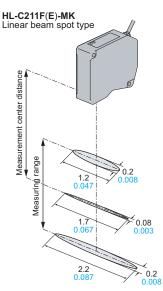


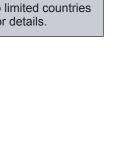












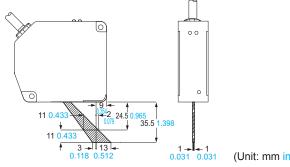
PRECAUTIONS FOR PROPER USE

Refer to p.1501 for general precautions and p.1499~ for information about laser beam.

Mutual interference

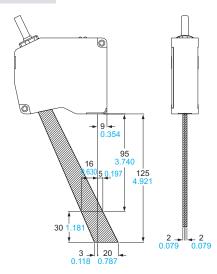
- · When installing two or more sensor heads side by side, mutual interference will not occur if the laser spots from other sensor heads do not fall within the shaded areas of the sensor head in the figure below.
- · When connecting two sensor heads to one controller, the mutual interference prevention function can be used. Therefore the measures shown below are not necessary.

HL-C203F□



(Unit: mm in)

HL-C211F

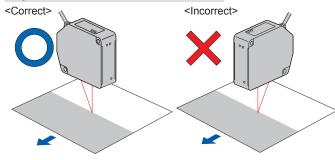


(Unit: mm in)

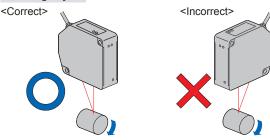
Sensor head mounting direction

• To obtain the greatest precision, the sensor head should be oriented facing the direction of movement of the object's surface, as shown in the figure below.

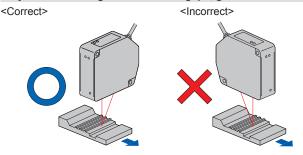
Object with variations in material or color



Rotating object



Object that has large differences in gaps, grooves and colors



Safety standards for laser beam products

• A laser beam can harm human being's eyes, skin, etc., because of its high energy density. IEC has classified laser products according to the degree of hazard and the stipulated safety requirements. The HL-C2 series is classified as Class 1 / Class 2 / Class 3R laser. (Refer to p.1499~ for information about laser beam.)

Safe use of laser products

• For the purpose of preventing users from suffering injuries by laser products, IEC 60825-1(Safety of laser products). Kindly check the standards before use. (Refer to p.1499~ for information about laser beam.)

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Displacement

Magnetic
Displacement

Collimated
Beam

Digital Panel
Controller

Metai-Seed

HL-G1

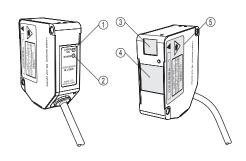
HL-C2 HL-C1

PRECAUTIONS FOR PROPER USE

Refer to p.1501 for general precautions and p.1499~ for information about laser beam.

Fuctional description

Sensor head



	Description	Function
1	Laser emission indicator (Green LED)	Lights up during laser emission.
2	Measurement range indicator (Yellow LED)	Lights up when the target reaches at approximately center of the measurement. Blinks when the target enters within the measurement range. Turns off the light when the target goes out of the measurement range.
3	Light emitter	Emits the laser light.
4	Light receiver	Receives the laser specular light from a measurement target.
5	Warning label	Shows the laser emission position. Please read carefully before use.

	Description	Function
1	POWER indicator	Lights up in green when electricity is provided to the controller.
2	ALM1 (Alarm) indicator	Abnormal condition indicator for OUT1. Lights up in red during dark status (poor light intensity) of OUT1 or the sensor head is in unconnected status.
3	ALM2 (Alarm) indicator	Abnormal condition indicator for OUT2. Lights up in red during dark status (poor light intensity) of OUT2 or the sensor head is in unconnected status.
4	LASER A indicator	Lights up in green during the laser radiation of Head A.
(5)	LASER B indicator	Lights up in green during the laser radiation of Head B.
6	Analog output terminal	Terminal for analog data output.
7	Laser control terminal	Stops laser emission in case of short-circuiting.
8	Remote interlock terminal	Stops laser emission when its opened.
9	Ethernet connector	Built into HL-C21C(E), HL-C21C(E)-P. Used for communication with the control devices using Ethernet.
10	USB connector	Used for communication with PC using USB.
11)	Console connection connector	Used for connecting the mini console.
12	RS-232C connector	Built into HL-C2C(E), HL-C2C(E)-P. Used for communication with the control devices using RS-232C.
13	I/O terminal	Terminal for various I/O. Used for communication with the control devices using Ethernet and memory change.
(14)	Power terminal	Terminal for power supply to the controller.
(15)	Sensor head A connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head A" and starts operation.
16	Sensor head B connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head B" and starts operation.
17)	DIN rail mounting hook	Used for hooking/removing the sensor heads to/from the 35mm width DIN rail with one-touch simple operation.

Note: In case of connecting one sensor head to the controller, be sure to connect the sensor head to (§) the sensor head A connection (HEAD A) side. If the sensor head is connected to (§) the sensor head B connection (HEAD B) side, the measurement cannot be performed.

(550 21.654) ø6.6 <mark>ø0.260</mark>

2-M5 Mounting holes, 8 0.315 deep

(4.50.177)

DIMENSIONS (Unit: mm in)

HL-C201F(E) HL-C201F(E)-MK

Set mode: Specular reflection

r distance/ Beam-emitting axis

HL-C203F(E) HL-C203F(E)-MK

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The CAD data in the dimensions can be downloaded from our website.

LASER SENSORS

MICRO PHOTO-ELECTRIC SENSORS

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WIRE-SAVING SYSTEMS

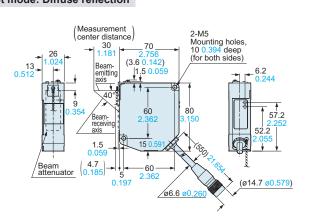
Sensor head

LASER MARKERS

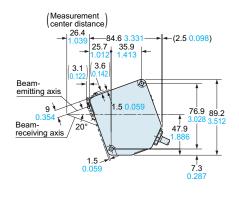
FA COMPONENTS

MACHINE

Set mode: Diffuse reflection



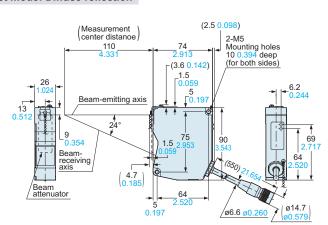
Set mode: Specular reflection



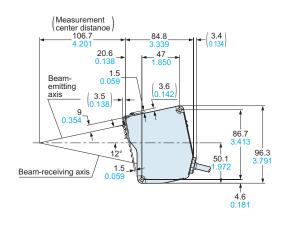
HL-C211F□(E) HL-C211F□(E)-MK

Sensor head

Set mode: Diffuse reflection



Set mode: Specular reflection



Digital Panel Controller

HL-G1

HL-C2

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HL-C2

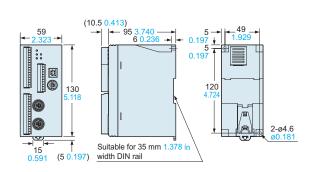
HL-C1

DIMENSIONS (Unit: mm in)

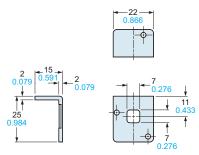
The CAD data in the dimensions can be downloaded from our website.

HL-C2C(E) HL-C2C(E)-P HL-C21C(E) HL-C21C(E)-P

Controller

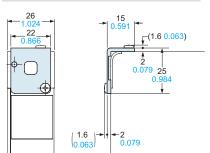


ND filter HL-C2F01



Material: Alminum (Mounting retention) Glass (ND part)

Mounting drawing with a sensor head



Notes: 1) Mounting cannot be preformed when the beam attenuator of the sensor head is in use.

- 2) **HL-C201F** (-MK) cannot be mounted.
- 3) Do not mount it in using a beam attenuator.